# 502167029 12/18/2012

# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Chih-Chang LIN	07/12/2010
Chan-Hong CHERN	07/12/2010
Steven SWEI	07/12/2010
Ming-Chieh HUANG	07/12/2010
Tien-Chun YANG	07/12/2010

#### RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.	
Street Address:	No. 8, Li-Hsin Rd. VI, Hsinchu Science Park	
City:	Hsinchu	
State/Country:	TAIWAN	
Postal Code:	300	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13718235

## CORRESPONDENCE DATA

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NAME OF SUBMITTER:	Randy A. Noranbrock

Total Attachments: 1 source=efiledassgn#page1.tif

PATENT REEL: 029490 FRAME: 0754 P \$40.00 1371823

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Docket No.: T5057-Y240

# ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

1) Chih-Chang LIN

- 4) Ming-Chieh HUANG
- 2) Chan-Hong CHERN
- 5) Tien-Chun YANG

3) Steven SWEI

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

#### TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD, having a place of business at

### No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

#### PHASE-LOCK ASSISTANT CIRCUITRY

- (a) for which an application for United States Letters Patent was filed on  $\frac{7-13-10}{}$ , and identified by United States Patent Application No.  $\frac{12/835,130}{}$ ; or
- (b) for which an application for United States Letters Patent was executed on

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

> PATENT REEL: 029490 FRAME: 0755

**RECORDED: 12/18/2012**